

300 kW Full-Liquid AI Rack Emulator

Rack-scale liquid thermal emulation for high-density AI data-centre commissioning.

 LIQUID LOAD
300 kW

 ARCHITECTURE
Full Liquid

 VOLTAGE
380-480 V

 RESOLUTION
1 kW

Validate the liquid-cooling chain before compute goes live



Create controlled rack-scale liquid heat load without depending on production servers.



Exercise CDU capacity, branch flow, pressure and temperature response in staged demand conditions.



Support extended loading, redundancy checks and recovery scenarios under the project commissioning plan.



Apply repeatable electrical demand to validate upstream rack power and distribution interfaces.



TECHNICAL SPECIFICATIONS

Rated power	300 kW
Cooling architecture	Full liquid
Rated voltage	AC 380 / 400 / 415 / 480 V
Loading resolution	1 kW
Reference dimensions	600 × 1300 × 2300 mm
Power factor	1.0 resistive load
Control	Local touchscreen; remote control optional
Monitoring	Voltage, current, active power, frequency, liquid-side temperature, flow and pressure functions
Protection	Over-voltage, over-current, over-temperature, overload, low-flow, high-temperature and leak protection
Environment	+5°C to +50°C; RH ≤ 90%; altitude ≤ 1500 m
Enclosure	IP20 indoor



 Product appearance and interfaces may vary by project. Connectors, hoses, controls, documentation and application notes are finalized to suit the approved commissioning plan.

COMMISSIONING APPLICATIONS

- Direct-to-chip cooling validation
- CDU + secondary-loop testing
- AI rack heat-load testing
- Facility thermal response
- Functional / integrated test support

AMOR PROJECT DELIVERY SUPPORT



CONFIGURE
Project requirements +
equipment selection



MOBILIZE
Delivery + temporary
interface coordination



SUPPORT
Setup + operation +
troubleshooting



INTEGRATE
Work under the approved
project test plan